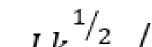
# Non-Ionizing Radiation Effects on the Surface Recombination Velocity of AlGaAs/GaAs Double Heterostructures

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Abstract	Heterostructure	TRPL System
We used time resolved photoluminescence to extract the room temperature surface recombination velocities and bulk carrier recombination lifetimes for a series of AlGaAs/GaAs heterostructures exposed to 1 MeV equivalent in Si neutron radiation. While the measured exposure effects were dominated by the bulk, a statistically significant increase in the surface recombination velocity was determined for fluences in excess of 5x10 <sup>12</sup> n/cm <sup>2</sup> . This result suggests that radiation effects on the surface recombination velocity become an important factor for modeling and qualification purposes when devices are exposed above a threshold fluence.	Cap: GaAs (20 nm)Barrier: Al_{0.38}Ga _{0.62}As (100 nm)Active Region: GaAs (500 nm, 1000nm, 1500 nm)Barrier: Al_{0.38}Ga _{0.62}As (100 nm)Buffer: GaAs (200 nm)Substrate: GaAsFigure 1: Sample structure.	Cryostat and SampleImage: OPA image: OPA im

**Equations: Carrier Recombination Dynamics** 



 $\tau_{PL}^{-1} = k_{PL} = (k_{rad} + k_{nr-SRH})$ Eq.1: Carrier recombination rate.

 $k_{PL} = k_{bulk} + (S_1 + S_2)L^{-1}$ 

Eq. 2: Bulk and surface recombination.

 $Lk_{bulk}^{1/2} / D^{1/2} \ll 1$ 

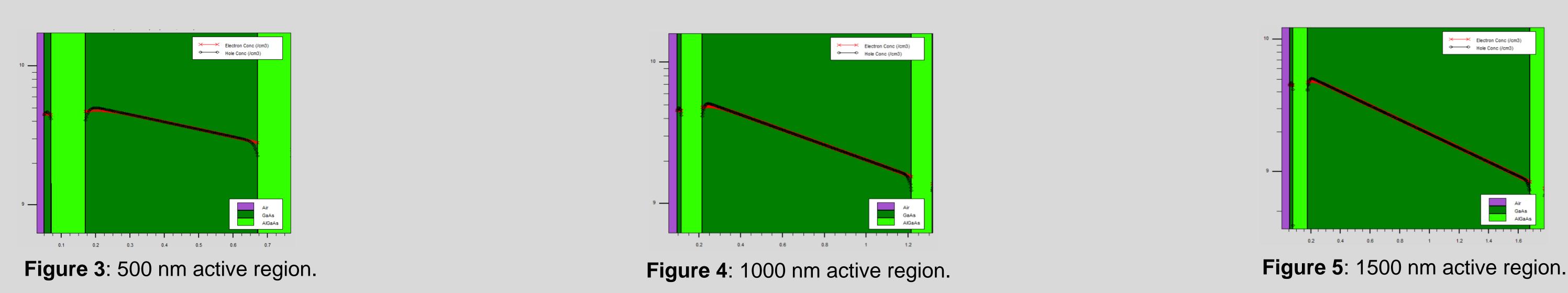
Eq. 3: Uniform carrier excitation condition.

 $k_{PL} = k_{rad} + k_{nr-SRH} + 2SL^{-1}$ ;  $S_1 = S_2$ 

Eq. 4: Simplified bulk and surface recombination.

Electron Conc (/cm3
Hole Conc (/cm3)

## Silvaco Simulations, T ~ 295 K



To determine the relative pulse energies to be used for the time resolved characterization the ratios of the concentrations derived from Figs. 3 - 5 were considered. The average of the front and back interface concentrations were determined for each structure and then compared. The analysis suggests that the pulse energy for the 1000 nm and 1500 nm test articles should be increased by 20% and 30% respectively relative to that of the 500 nm sample to maintain a near constant carrier density. This was performed for the TRPL data collection to minimize carrier density dependent effects.

# Effects of Neutron Exposure on Bulk and Surface Recombination Rates, T ~ 295 K

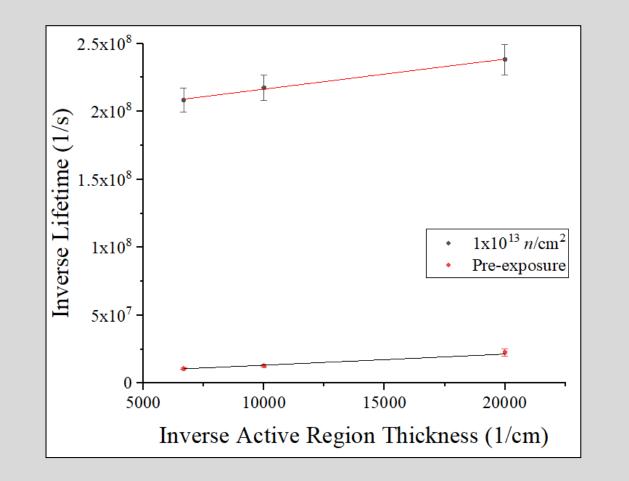
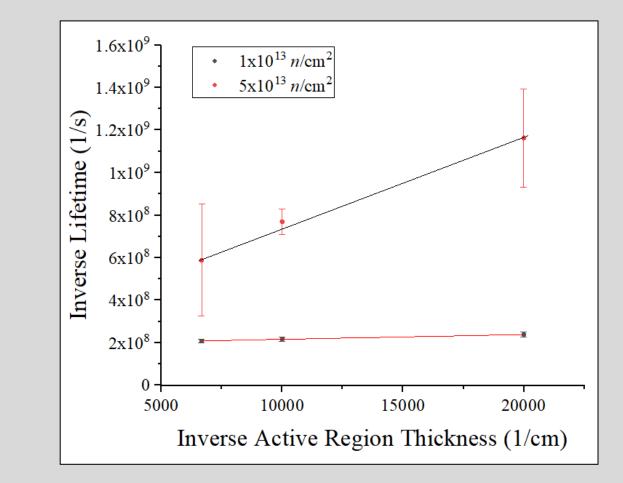
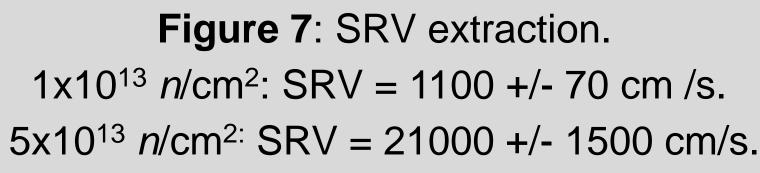


Figure 6: SRV extraction. Unexposed: SRV =  $460 \pm 7$  cm/s.  $1 \times 10^{13} n/cm^2$ : SRV = 1100 +/- 70 cm/s.





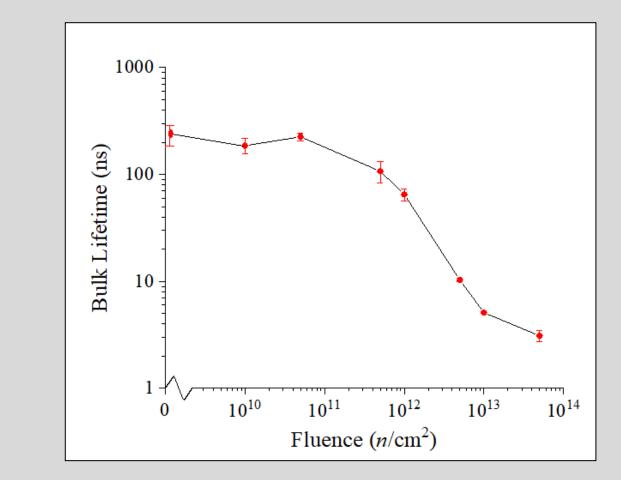


Figure 8: Bulk carrier lifetime.

Linear fits of the extracted 1/e carrier recombination lifetimes as a function of active region thickness (Eq. 4) were used to extract the bulk carrier lifetime and the SRV for a given exposure fluence. For simplicity, this analysis assumes that the surface recombination characteristics at each AlGaAs/GaAs interface are comparable ( $S_1 = S_2$ ). A comparison of the unexposed test articles to those subjected to a fluence of 1x10<sup>13</sup> n/cm<sup>2</sup> is shown in Fig. 6. The slope of each is proportional to the SRV. Similarly, a comparison of the data for test articles exposed to fluences of 1x10<sup>13</sup> n/cm<sup>2</sup> and 5x10<sup>13</sup> n/cm<sup>2</sup> appears in Fig. 7. An examination of the extracted bulk carrier lifetime as a function of fluence appears in Fig. 8. A reduction in the carrier lifetime relative to the unexposed value is significant to 1 - s becomes evident for fluences in excess of  $5 \times 10^{10}$  n/cm<sup>2</sup>. An overall lifetime reduction by over two orders of magnitude occurs for the largest fluence of  $5 \times 10^{13}$  n/cm<sup>2</sup>.

### Changes to Bulk and Surface Recombination Rates

#### Summary

An increase in the SRV significant to  $1-\sigma$ becomes apparent for fluences in excess of 5x10<sup>12</sup> n/cm<sup>2</sup>. For comparison, the bulk carrier recombination rates (inverse of the extracted bulk carrier lifetime) are plotted alongside the SRV in Fig. 9. The results show that statistically significant radiation-induced degradation begins to occur at a lower fluence in the bulk than at the AlGaAs/GaAs interfaces. However, at the highest fluence the SRV increases by over one order of magnitude relative to the unexposed value.

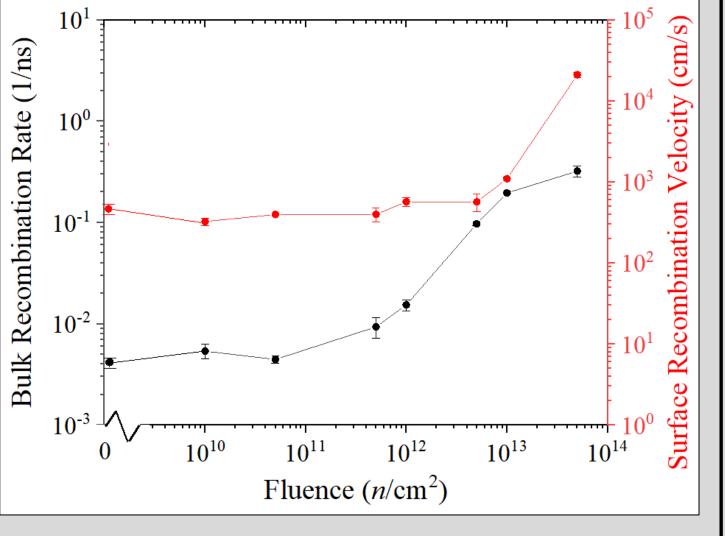


Figure 9: Bulk and surface recombination rates.

It was determined that 1 MeV equivalent in Si neutron radiation has a measurable impact on the bulk recombination rate for AlGaAs/GaAs test structures, likely through the generation of non-radiative recombination centers. Non-ionizing radiation exposure also increases the surface recombination velocity for fluences in excess of 5x10<sup>12</sup> n/cm<sup>2</sup>. The results indicate that at lower radiation fluences the impact of non-radiative recombination at interfaces in complex structures might not represent a significant source of degradation or performance reduction. However, the SRV radiation threshold suggests that this may be a concern for applications in severe environments, especially if the photovoltaic device structure incorporates multiple interfaces, such as for a superlattice.

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